MCP23018/MCP23S18

16-Bit I/O Expander with Open-Drain Outputs
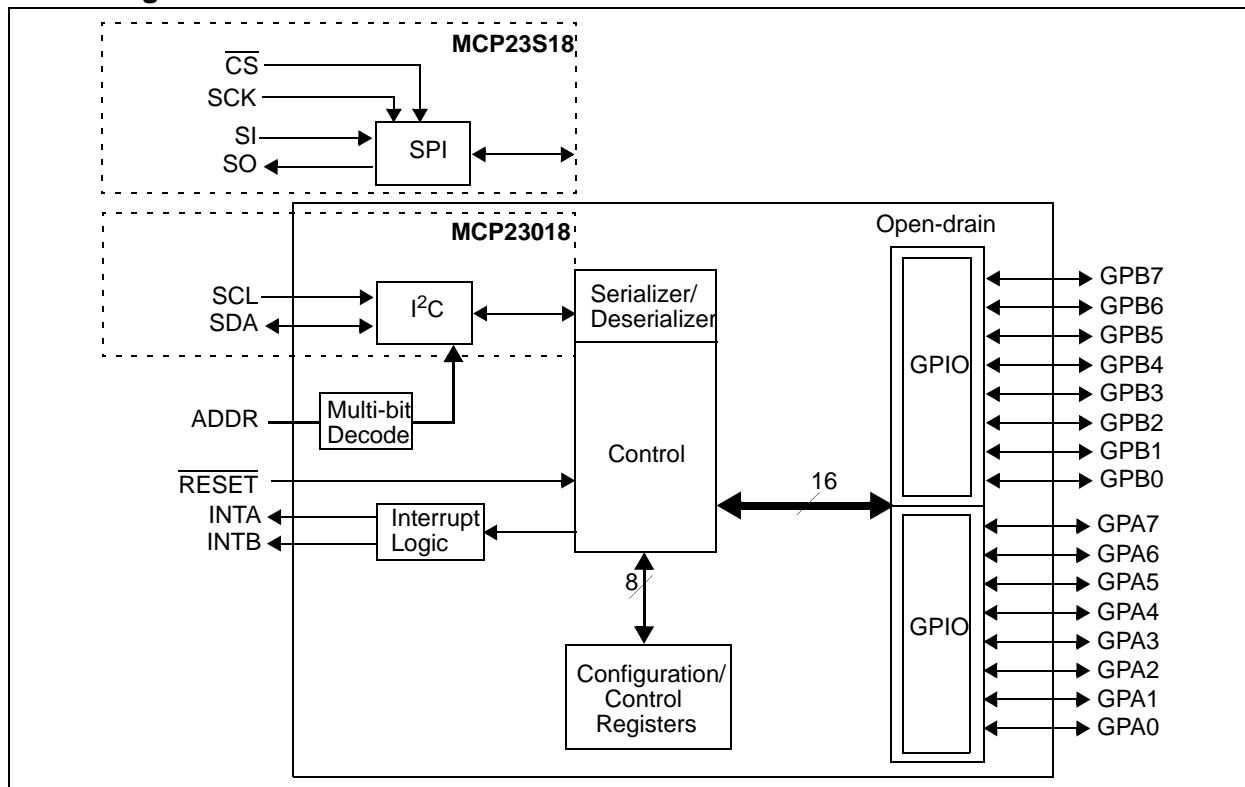
Features

- 16-bit remote bidirectional I/O port:
  - I/O pins default to input
- Open-drain outputs:
  - 5.5V tolerant
  - 25 mA sink capable (per pin)
  - 400 mA total
- High-speed I^{2}C™ interface: (**MCP23018**)
  - 100 kHz
  - 400 kHz
  - 3.4 MHz
- High-speed SPI interface: (**MCP23S18**)
  - 10 MHz: 2.7V $\leq$ V$_{DD}$ $\leq$ 5.5V
- Single hardware address pin: (**MCP23018**)
  - Voltage input to allow up to eight devices on the bus
- Configurable interrupt output pins:
  - Configurable as active-high, active-low or open-drain

- Configurable interrupt source:
  - Interrupt-on-change from configured defaults or pin change
- Polarity inversion register to configure the polarity of the input port data
- External reset input
- Low standby current:
  - 1 µA (-40°C $\leq$ T$_A$ $\leq$ +85°C)
  - 6 µA (+85°C $\leq$ T$_A$ $\leq$ +125°C)
- Operating voltage:
  - 1.8V to 5.5V

Packages

28-pin PDIP (300 mil)

28-pin SOIC (300 mil)

24-pin SSOP (MCP23018 only)

24-pin QFN (4x4 [mm])

Block Diagram

MCP23018/MCP23S18

Package Types:

MCP23018

PDIP/SOIC

Vss	1	28	NC
NC	2	27	GPA7
GPB0	3	26	GPA6
GPB1	4	25	GPA5
GPB2	5	24	GPA4
GPB3	6	23	GPA3
GPB4	7	22	GPA2
GPB5	8	21	GPA1
GPB6	9	20	GPA0
GPB7	10	19	INTA
VDD	11	18	INTB
SCL	12	17	NC
SDA	13	16	$\overline{RESET}$
NC	14	15	ADDR

SSOP

Vss	1	24	GPA7
GPB0	2	23	GPA6
GPB1	3	22	GPA5
GPB2	4	21	GPA4
GPB3	5	20	GPA3
GPB4	6	19	GPA2
GPB5	7	18	GPA1
GPB6	8	17	GPA0
GPB7	9	16	INTA
VDD	10	15	INTB
SCL	11	14	$\overline{RESET}$
SDA	12	13	ADDR

QFN

Top pins: GPB0 (24), Vss (23), GPA7 (22), GPA6 (21), GPA5 (20), GPA4 (19)

GPB1	1	18	GPA3
GPB2	2	17	GPA2
GPB3	3	16	GPA1
GPB4	4	15	GPA0
GPB5	5	14	INTA
GPB6	6	13	INTB

EP 25

Bottom pins: GPB7 (7), VDD (8), SCL (9), SDA (10), ADDR (11), $\overline{RESET}$ (12)

Package Types:

MCP23S18

PDIP/SOIC

Vss	1	28	NC
NC	2	27	GPA7
GPB0	3	26	GPA6
GPB1	4	25	GPA5
GPB2	5	24	GPA4
GPB3	6	23	GPA3
GPB4	7	22	GPA2
GPB5	8	21	GPA1
GPB6	9	20	GPA0
GPB7	10	19	INTA
VDD	11	18	INTB
CS	12	17	NC
SCK	13	16	RESET
SI	14	15	SO

QFN *

QFN pin assignments:

Top (left to right): GPB0 (24), Vss (23), GPA7 (22), GPA6 (21), GPA5 (20), GPA4 (19)

Left side: GPB1 (1), GPB2 (2), GPB3 (3), GPB4 (4), GPB5 (5), GPB6 (6)

Right side: GPA3 (18), GPA2 (17), GPA1 (16), GPA0 (15), INTA * (14), RESET (13)

Bottom (left to right): GPB7 (7), VDD (8), CS (9), SCK (10), IS (11), OS (12)

Center: EP 25

* INTB is not bonded out. Can be controlled in IOCON.MIRROR

1.0   DEVICE OVERVIEW

The MCP23X18 device provides 16-bit, general purpose parallel I/O expansion for I^2C bus or SPI applications. The two devices differ only in the serial interface.

- MCP23018 - I^2C interface
- MCP23S18 - SPI interface

The MCP23X18 consists of multiple 8-bit configuration registers for input, output and polarity selection. The system master can enable the I/Os as either inputs or outputs by writing the I/O configuration bits. The data for each input or output is kept in the corresponding input or output register. The polarity of the input port register can be inverted with the polarity inversion register. All registers can be read by the system master.

The 16-bit I/O port functionally consists of two (2) 8-bit ports (PORTA and PORTB). The MCP23X18 can be configured to operate in 8-bit mode or 16-bit mode via IOCON.BANK.

There are two interrupt pins, INTA and INTB which can be associated with their respective ports, or can be logically OR'ed together so both pins will activate if either port causes an interrupt.

The interrupt output can be configured to activate under two conditions (mutually exclusive):

1. When any input state differs from its corresponding input port register state. This is used to indicate to the system master that an input state has changed.
2. When an input state differs from a pre-configured register value (DEFVAL register).

The Interrupt Capture register captures port values at the time of the interrupt, thereby saving the condition that caused the interrupt.

The Power-on Reset (POR) sets the registers to their default values and initializes the device state machine.

The hardware address pin is used to determine the device address.

1.1 Pin Descriptions

TABLE 1-1: I²C PINOUT DESCRIPTION (MCP23018)

Pin Name	28L PDIP/ SOIC	24L QFN	24L SSOP	Pin Type	Standard Function
GPB0	3	24	2	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB1	4	1	3	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB2	5	2	4	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB3	6	3	5	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB4	7	4	6	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB5	8	5	7	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB6	9	6	8	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB7	10	7	9	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
V_{DD}	11	8	10	P	Power
V_{SS}	1	23	1	P	Ground
SCL	12	9	11	I	Serial clock input
SDA	13	10	12	I/O	Serial data I/O
ADDR	15	11	13	I	Hardware address pin allows up to 8 slave devices on the bus
RESET	16	12	14	I	Hardware reset
INTB	18	13	15	O	Interrupt output for port B. Can be configured as active high, active low, or open drain.
INTA	19	14	16	O	Interrupt output for port A. Can be configured as active high, active low, or open drain.
GPA0	20	15	17	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA1	21	16	18	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA2	22	17	19	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA3	23	18	20	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA4	24	19	21	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA5	25	20	22	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA6	26	21	23	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA7	27	22	24	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
NC	2, 14, 17, 28	—	—		Not connected
EP	—	25	—		Exposed Thermal Pad (EP). Do not electrically connect, or connect to Vss.

MCP23018/MCP23S18

TABLE 1-2: **SPI PINOUT DESCRIPTION (MCP23S18)**

Pin Name	28L PDIP/ SOIC	24L QFN	Pin Type	Standard Function
GPB0	3	24	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB1	4	1	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB2	5	2	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB3	6	3	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB4	7	4	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB5	8	5	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB6	9	6	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPB7	10	7	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
V_{DD}	11	8	P	Power (high current capable)
V_{SS}	1	23	P	Ground (high current capable)
CS	12	9	I	Chip select
SCK	13	10	I	Serial clock input
SI	14	11	I	Serial data input
SO	15	12	O	Serial data out
RESET	16	13	I	Hardware reset (must be externally biased)
INTB	18	—	O	Interrupt output for port B. Can be configured as active high, active low, or open drain.
INTA	19	14	O	Interrupt output for port A. Can be configured as active high, active low, or open drain.
GPA0	20	15	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA1	21	16	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA2	22	17	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA3	23	18	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA4	24	19	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA5	25	20	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA6	26	21	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
GPA7	27	22	I/O	Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor.
NC	2, 17, 28	—		Not connected
EP	—	25	—	Exposed Thermal Pad (EP). Do not electrically connect, or connect to VSS.

1.2 Power-on Reset (POR)

The on-chip POR circuit holds the device in reset until V_{DD} has reached a high enough voltage to deactivate the POR circuit (i.e., release the device from reset). The maximum V_{DD} rise time is specified in the electrical specification section.

When the device exits the POR condition (releases reset), device operating parameters (i.e., voltage, temperature, serial bus frequency, etc.) must be met to ensure proper operation.

1.3 Serial Interface

This block handles the functionality of the I^2C (MCP23018) or SPI (MCP23S18) interface protocol. The MCP23X18 contains twenty two (22) individual registers (eleven [11] register pairs) which can be addressed through the Serial Interface block (Table 1-1).

TABLE 1-1: REGISTER ADDRESSES

Address IOCON.BANK = 1	Address IOCON.BANK = 0	Access to:
00h	00h	IODIRA
10h	01h	IODIRB
01h	02h	IPOLA
11h	03h	IPOLB
02h	04h	GPINTENA
12h	05h	GPINTENB
03h	06h	DEFVALA
13h	07h	DEFVALB
04h	08h	INTCONA
14h	09h	INTCONB
05h	0Ah	IOCON
15h	0Bh	IOCON
06h	0Ch	GPPUA
16h	0Dh	GPPUB
07h	0Eh	INTFA
17h	0Fh	INTFB
08h	10h	INTCAPA
18h	11h	INTCAPB
09h	12h	GPIOA
19h	13h	GPIOB
0Ah	14h	OLATA
1Ah	15h	OLATB

1.3.1 BYTE MODE AND SEQUENTIAL MODE

The MCP23X18 has the ability to operate in "Byte Mode" or "Sequential Mode" (IOCON.SEQOP). Byte mode and sequential mode are not to be confused with I^2C byte operations and sequential operations. The modes explained here relate to the device's internal address pointer and whether or not it is incremented after each byte is clocked on the serial interface.

Byte Mode disables automatic address pointer incrementing. When operating in Byte Mode, the MCP23X18 does not increment its internal address counter after each byte during the data transfer. This gives the ability to continually access the same address by providing extra clocks (without additional control bytes). This is useful for polling the GPIO register for data changes or for continually writing to the output latches.

A special mode **(Byte Mode with IOCON.BANK = 0)** causes the address pointer to toggle between associated A/B register pairs. For example, if the BANK bit is cleared and the address pointer is initially set to address 12h (GPIOA) or 13h (GPIOB), the pointer will toggle between GPIOA and GPIOB. Note, the address pointer can initially point to either address in the register pair.

Sequential Mode enables automatic address pointer incrementing. When operating in Sequential Mode, the MCP23X18 increments its address counter after each byte during the data transfer. The address pointer automatically rolls over to address 00h after accessing the last register.

These two modes are not to be confused with single writes/reads and continuous writes/reads which are serial protocol sequences. For example, the device may be configured for Byte Mode and the master may perform a continuous read. In this case, the MCP23X18 would not increment the address pointer and would repeatedly drive data from the same location.

1.3.2 I^2C INTERFACE

1.3.2.1 I^2C Write Operation

The I^2C write operation includes the control byte and register address sequence, as shown in the bottom of Figure 1-1. This sequence is followed by eight bits of data from the master and an Acknowledge (ACK) from the MCP23018. The operation is ended with a stop (P) or restart (SR) condition being generated by the master.

Data is written to the MCP23018 after every byte transfer. If a stop or restart condition is generated during a data transfer, the data will not be written to the MCP23018.

Both "byte mode" and "sequential mode" are supported by the MCP23018. If sequential mode is enabled (default), the MCP23018 increments its address counter after each ACK during the data transfer.

1.3.2.2 I^{2}C Read Operation

I^{2}C read operations include the control byte sequence, as shown in the bottom of Figure 1-1. This sequence is followed by another control byte (including the Start condition and ACK) with the R/W bit equal to a logic one (R/W = 1). The MCP23018 then transmits the data contained in the addressed register. The sequence is ended with the master generating a Stop or Restart condition.

1.3.2.3 I^{2}C Sequential Write/Read

For sequential operations (Write or Read), instead of transmitting a Stop or Restart condition after the data transfer, the master clocks the next byte pointed to by the address pointer (see **Section 1.3.1 "Byte Mode and Sequential Mode"** for details regarding sequential operation control).

The sequence ends with the master sending a Stop or Restart condition.

The MCP23018 address pointer will roll over to address zero after reaching the last register address.

Refer to Figure 1-1.

1.3.3 SPI INTERFACE

1.3.3.1 SPI Write Operation

The SPI write operation is started by lowering $\overline{CS}$. The write command (slave address with R/W bit cleared) is then clocked into the device. The opcode is followed by an address and at least one data byte.

1.3.3.2 SPI Read Operation

The SPI read operation is started by lowering $\overline{CS}$. The SPI read command (slave address with R/W bit set) is then clocked into the device. The opcode is followed by an address, with at least one data byte being clocked out of the device.

1.3.3.3 SPI Sequential Write/Read

For sequential operations, instead of deselecting the device by raising $\overline{CS}$, the master clocks the next byte pointed to by the address pointer. (see **Section 1.3.1 "Byte Mode and Sequential Mode"** for details regarding sequential operation control).

The sequence ends by the raising of $\overline{CS}$.

The MCP23S18 address pointer will roll over to address zero after reaching the last register address.

FIGURE 1-1: MCP23018 I²C™ DEVICE PROTOCOL

1.4 Multi-bit Address Decoder

The ADDR pin is used to set the slave address of the MCP23018 (I^2C only) to allow up to eight devices on the bus using only a single pin. Typically, this would require three pins.

The multi-bit Address Decoder employs a basic FLASH ADC architecture (Figure 1-4). The seven comparators generate 8 unique values based on the analog input. This value is converted to a 3-bit code which corresponds to the address bits (A2, A1, A0) in the serial OPCODE.

Sequence of Operation (see Figure 1-5 for timings):

1. Upon power up (after VDD stabilizes) the module becomes active after time tADEN. Note, the analog value on the ADDR pin must be stable before this point to ensure accurate address assignment.

2. The 3-bit address is latched after tADDRLAT.

3. The module powers down after the first rising edge of the serial clock is detected (tADDIS).

Once the address bits are latched, the device will keep the slave address until a POR or reset condition occurs.

1.4.1 CALCULATING VOLTAGE ON ADDR

When calculating the required voltage on the ADDR pin (V2), the set point should be the mid-point of the LSb of the ADC.

The examples in Figure 1-2 and Figure 1-3 show how to determine the mid point voltage (V2) and the range of voltages based on a voltage divider circuit. The maximum tolerance is 20%, however, it is recommended to use 5% tolerance worst case (10% total tolerance).

FIGURE 1-2: VOLTAGE DIVIDER EXAMPLE
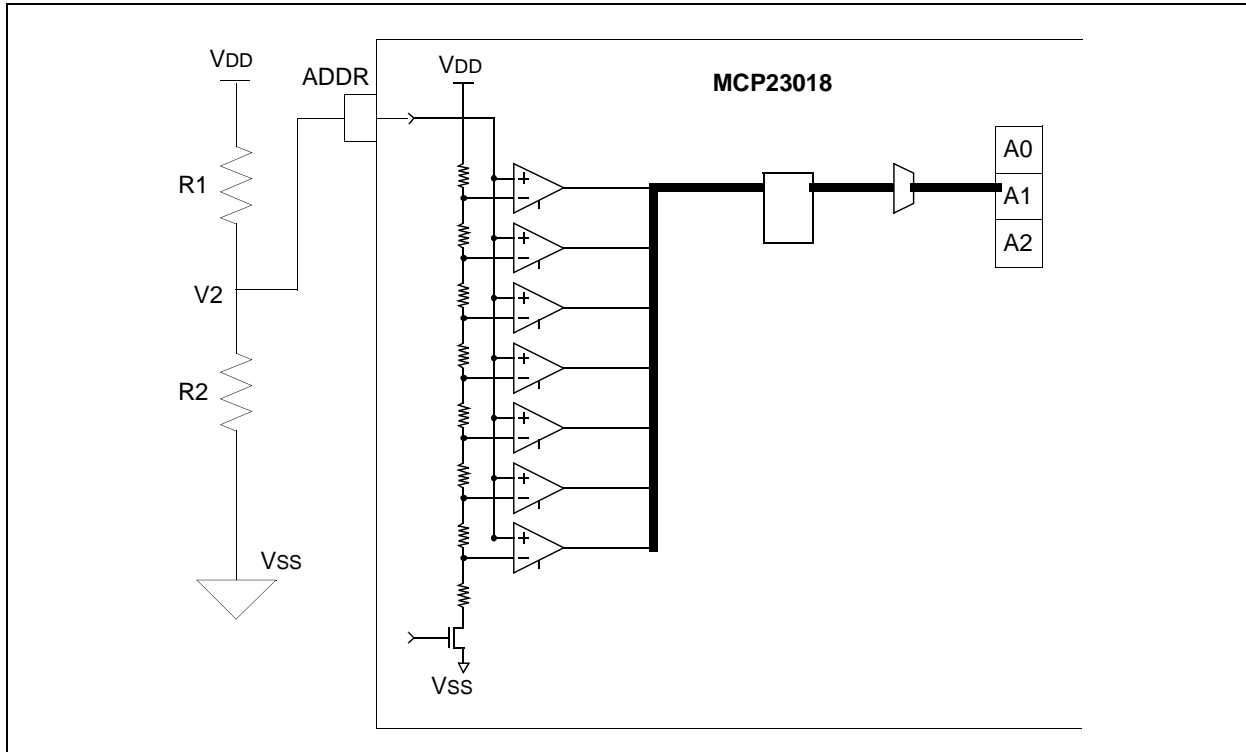
FIGURE 1-3: **VOLTAGE AND CODE EXAMPLE**

Assume:

n = A2, A1, A0 in opcode

ratio = R2/(R1+R2)

V2 = voltage on ADDR pin

V2(min) = V2 - (VDD/8) x %tolerance

V2(max) = V2 + (VDD/8) x %tolerance

				VDD= 1.8	10% Tolerance (total)	
n	R2=2n+1	R1=16-R2	R2/(R1+R2)	V2	V2(min)	V2(max)
0	1	15	0.0625	**0.113**	0.00	0.14
1	3	13	0.1875	**0.338**	0.32	0.36
2	5	11	0.3125	**0.563**	0.54	0.59
3	7	9	0.4375	**0.788**	0.77	0.81
4	9	7	0.5625	**1.013**	0.99	1.04
5	11	5	0.6875	**1.238**	1.22	1.26
6	13	3	0.8125	**1.463**	1.44	1.49
7	15	1	0.9375	**1.688**	1.67	1.80

				VDD= 2.7	10% Tolerance (total)	
n	R2=2n+1	R1=16-R2	R2/(R1+R2)	V2	V2(min)	V2(max)
0	1	15	0.0625	**0.169**	0.00	0.19
1	3	13	0.1875	**0.506**	0.48	0.53
2	5	11	0.3125	**0.844**	0.82	0.87
3	7	9	0.4375	**1.181**	1.16	1.20
4	9	7	0.5625	**1.519**	1.50	1.54
5	11	5	0.6875	**1.856**	1.83	1.88
6	13	3	0.8125	**2.194**	2.17	2.22
7	15	1	0.9375	**2.531**	2.51	2.70

				VDD= 3.3	10% Tolerance (total)	
n	R2=2n+1	R1=16-R2	R2/(R1+R2)	V2	V2(min)	V2(max)
0	1	15	0.0625	**0.206**	0.00	0.23
1	3	13	0.1875	**0.619**	0.60	0.64
2	5	11	0.3125	**1.031**	1.01	1.05
3	7	9	0.4375	**1.444**	1.42	1.47
4	9	7	0.5625	**1.856**	1.83	1.88
5	11	5	0.6875	**2.269**	2.25	2.29
6	13	3	0.8125	**2.681**	2.66	2.70
7	15	1	0.9375	**3.094**	3.07	3.30

				VDD= 5.5	10% Tolerance (total)	
n	R2=2n+1	R1=16-R2	R2/(R1+R2)	V2	V2(min)	V2(max)
0	1	15	0.0625	**0.344**	0.00	0.37
1	3	13	0.1875	**1.031**	1.01	1.05
2	5	11	0.3125	**1.719**	1.70	1.74
3	7	9	0.4375	**2.406**	2.38	2.43
4	9	7	0.5625	**3.094**	3.07	3.12
5	11	5	0.6875	**3.781**	3.76	3.80
6	13	3	0.8125	**4.469**	4.45	4.49
7	15	1	0.9375	**5.156**	5.13	5.50

MCP23018/MCP23S18

FIGURE 1-4: **FLASH ADC BLOCK DIAGRAM**

FIGURE 1-5: **HARDWARE ADDRESS DECODE TIMING**

1.4.2 ADDRESSING I^{2}C DEVICES (MCP23018)

The MCP23018 is a slave I^{2}C device that supports 7-bit slave addressing, with the read/write bit filling out the control byte. The slave address contains four fixed bits and three user-defined hardware address bits (pins A2, A1, and A0). Figure 1-6 shows the control byte format.

1.4.3 ADDRESSING SPI DEVICES (MCP23S18)

The MCP23S18 is a slave SPI device. The slave address contains seven fixed bits(no address bits) with the read/write bit filling out the control byte. Figure 1-7 shows the control byte format.

FIGURE 1-6: **I^{2}C™ CONTROL BYTE FORMAT**

FIGURE 1-7: **SPI CONTROL BYTE FORMAT**

FIGURE 1-8: **I²C™ ADDRESSING REGISTERS**

S	0	1	0	0	A2	A1	A0	0	ACK	A7	A6	A5	A4	A3	A2	A1	A0	ACK

R/W = 0

←————— Device Opcode —————→   ←————————— Register Address —————————→

The ACKs are provided by the MCP23X18.

FIGURE 1-9: **SPI ADDRESSING REGISTERS**

CS

0	1	0	0	0	0	0	R/W	A7	A6	A5	A4	A3	A2	A1	A0

←————— Device Opcode —————→ ←————————— Register Address —————————→

1.5   GPIO Port

The GPIO module is a general purpose 16-bit wide bidirectional port which is functionally split into two (2) 8-bit wide ports.

The outputs are open-drain.

The GPIO module contains the data ports (GPIOn), internal pull up resistors and the Output Latches (OLATn).

The pull up resistors are individually configured and can be enabled when the pin is cofigured as an input or output.

Reading the GPIOn register reads the value on the port. Reading the OLATn register only reads the latches, not the actual value on the port.

Writing to the GPIOn register actually causes a write to the latches (OLATn). Writing to the OLATn register forces the associated output drivers to drive to the level in OLATn. Pins configured as inputs turn off the associated output driver and put it in high-impedance.

TABLE 1-2:   SUMMARY OF REGISTERS ASSOCIATED WITH THE GPIO PORTS (BANK = 1)

Register Name	Address (hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	POR/RST value
IODIRA	00	IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IPOLA	01	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
GPINTENA	02	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
GPPUA	06	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
GPIOA	09	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
OLATA	0A	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000
IODIRB	10	IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IPOLB	11	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
GPINTENB	12	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
GPPUB	16	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
GPIOB	19	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
OLATB	1A	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000

TABLE 1-3:   SUMMARY OF REGISTERS ASSOCIATED WITH THE GPIO PORTS (BANK = 0)

Register Name	Address (hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	POR/RST value
IODIRA	00	IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IODIRB	01	IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IPOLA	02	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
IPOLB	03	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
GPINTENA	04	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
GPINTENB	05	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
GPPUA	0C	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
GPPUB	0D	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
GPIOA	12	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
GPIOB	13	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
OLATA	14	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000
OLATB	15	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000

1.6 Configuration and Control Registers

There are twenty two (22) registers associated with the MCP23X18 as shown in Table 1-4 and Table 1-5. The two tables show the register mapping with the two BANK bit values. Ten (10) registers are associated

with Port A and ten (10) are associated with Port B. One register (IOCON) is shared between the two ports. The Port A registers are identical to the Port B registers, therefore, they will be referred to without differentiating between the port designation (i.e., they will not have the "A" or "B" designator assigned) in the register tables.

TABLE 1-4: CONTROL REGISTER SUMMARY (IOCON.BANK = 1)

Register Name	Address (hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	POR/RST value
IODIRA	00	IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IPOLA	01	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
GPINTENA	02	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
DEFVALA	03	DEF7	DEF6	DEF5	DEF4	DEF3	DEF2	DEF1	DEF0	0000 0000
INTCONA	04	IOC7	IOC6	IOC5	IOC4	IOC3	IOC2	IOC1	IOC0	0000 0000
IOCON	05	BANK	MIRROR	SEQOP	—	—	ODR	INTPOL	INTCC	0000 0000
GPPUA	06	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
INTFA	07	INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0	0000 0000
INTCAPA	08	ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0	0000 0000
GPIOA	09	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
OLATA	0A	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000
IODIRB	10	IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IPOLB	11	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
GPINTENB	12	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
DEFVALB	13	DEF7	DEF6	DEF5	DEF4	DEF3	DEF2	DEF1	DEF0	0000 0000
INTCONB	14	IOC7	IOC6	IOC5	IOC4	IOC3	IOC2	IOC1	IOC0	0000 0000
IOCON	15	BANK	MIRROR	SEQOP	—	—	ODR	INTPOL	INTCC	0000 0000
GPPUB	16	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
INTFB	17	INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0	0000 0000
INTCAPB	18	ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0	0000 0000
GPIOB	19	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
OLATB	1A	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000

TABLE 1-5: CONTROL REGISTER SUMMARY (IOCON.BANK = 0)

Register Name	Address (hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	POR/RST value
IODIRA	00	IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IODIRB	01	IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IPOLA	02	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
IPOLB	03	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
GPINTENA	04	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
GPINTENB	05	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
DEFVALA	06	DEF7	DEF6	DEF5	DEF4	DEF3	DEF2	DEF1	DEF0	0000 0000
DEFVALB	07	DEF7	DEF6	DEF5	DEF4	DEF3	DEF2	DEF1	DEF0	0000 0000
INTCONA	08	IOC7	IOC6	IOC5	IOC4	IOC3	IOC2	IOC1	IOC0	0000 0000
INTCONB	09	IOC7	IOC6	IOC5	IOC4	IOC3	IOC2	IOC1	IOC0	0000 0000
IOCON	0A	BANK	MIRROR	SEQOP	—	—	ODR	INTPOL	INTCC	0000 0000
IOCON	0B	BANK	MIRROR	SEQOP	—	—	ODR	INTPOL	INTCC	0000 0000
GPPUA	0C	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
GPPUB	0D	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
INTFA	0E	INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0	0000 0000
INTFB	0F	INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0	0000 0000
INTCAPA	10	ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0	0000 0000
INTCAPB	11	ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0	0000 0000
GPIOA	12	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
GPIOB	13	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
OLATA	14	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000
OLATB	15	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000

1.6.1   I/O DIRECTION REGISTER

Controls the direction of the data I/O.

When a bit is set, the corresponding pin becomes an input. When a bit is clear, the corresponding pin becomes an output.

REGISTER 1-3:   IODIR – I/O DIRECTION REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
IO7	IO6	IO5	IO4	IO3	IO2	IO1	IO0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 7-0   **IO7:IO0:** Controls the direction of data I/O <7:0>

       1 = Pin is configured as an input.
       0 = Pin is configured as an output.

1.6.2   INPUT POLARITY REGISTER

This register allows the user to configure the polarity on the corresponding GPIO port bits.

If a bit is set, the corresponding GPIO register bit will reflect the inverted value on the pin.

REGISTER 1-4:   IPOL – INPUT POLARITY PORT REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0   **IP7:IP0:** Controls the polarity inversion of the input pins <7:0>
1 = GPIO register bit will reflect the opposite logic state of the input pin.
0 = GPIO register bit will reflect the same logic state of the input pin.

1.6.3 INTERRUPT-ON-CHANGE CONTROL REGISTER

The GPINTEN register controls the interrupt-on-change feature for each pin.

If a bit is set, the corresponding pin is enabled for interrupt-on-change. The DEFVAL and INTCON registers must also be configured if any pins are enabled for interrupt-on-change.

REGISTER 1-5: GPINTEN – INTERRUPT-ON-CHANGE PINS

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0

bit 7   bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0   **GPINT7:GPINT0:** General purpose I/O interrupt-on-change pins <7:0>
   1 = Enable GPIO input pin for interrupt-on-change event
   0 = Disable GPIO input pin for interrupt-on-change event.

1.6.4   DEFAULT COMPARE REGISTER
          FOR INTERRUPT-ON-CHANGE

The default comparison value is configured in the DEFVAL register. If enabled (via GPINTEN and INTCON) to compare against the DEFVAL register, an opposite value on the associated pin will cause an interrupt to occur.

REGISTER 1-6:   DEFVAL – DEFAULT VALUE REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
DEF7	DEF6	DEF5	DEF4	DEF3	DEF2	DEF1	DEF0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0   **DEF7:DEF0:** Sets the compare value for pins configured for interrupt-on-change from defaults <7:0>. Refer to INTCON.

If the associated pin level is the opposite from the register bit, an interrupt occurs.

Refer to INTCON and GPINTEN.

1.6.5 INTERRUPT CONTROL REGISTER

The INTCON register controls how the associated pin value is compared for the interrupt-on-change feature. If a bit is set, the corresponding I/O pin is compared against the associated bit in the DEFVAL register. If a bit value is clear, the corresponding I/O pin is compared against the previous value.

REGISTER 1-7: INTCON – INTERRUPT-ON-CHANGE CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
IOC7	IOC6	IOC5	IOC4	IOC3	IOC2	IOC1	IOC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **IOC7:IOC0:** Controls how the associated pin value is compared for interrupt-on-change <7:0>.

1 = Pin value is compared against the associated bit is DEFVAL register
0 = Pin value is compared against the previous pin value.

Refer to INTCON and GPINTEN.

1.6.6 CONFIGURATION REGISTER

The IOCON register contains several bits for configuring the device:

The **BANK** bit changes how the registers are mapped (see Table 1-4 and Table 1-5 for more details).

- If BANK = 1, the registers associated with each port are segregated. Registers associated with PORTA are are mapped from address 00h - 0Ah and registers associated with PORTB are mapped from Address 10h - 1Ah

- If BANK = 0, the A/B registers are paired. For example, IODIRA is mapped to address 00h and IODIRB is mapped to the next address (address 01h). The mapping for all registers is from 00h - 15h

It is important to take care when changing the BANK bit as the address mapping changes after the byte is clocked into the device. The address pointer may point to an invalid location after the bit is modified.

For example, if the device is configured to automatically increment its internal address pointer the following scenario would occur:

- BANK = 0
- Write 80h to 0Ah (IOCON) to set the BANK bit
- After the write completes the internal address now points to 0Bh which is an invalid address when the BANK bit is set

For this reason, it is advised to only perform byte writes to this register when changing the BANK bit.

| **Note:** | The INTB pin is not bonded out on the MCP23S18 (SPI) device in the 24-lead QFN package. The **MIRROR** bit must be configured to a "1" in order for interrupts to be detected on PORTB. |

The **MIRROR** bit controls how the INTA and INTB pins function with respect to each other.

- When MIRROR = 1, the INTn pins are functionally OR'ed so that an interrupt on either port will cause both pins to activate

- When MIRROR = 0, the INT pins are separated. Interrupt conditions on a port will cause its respective INT pin to activate

The Sequential Operation (**SEQOP**) controls the incrementing function of the address pointer. If the address pointer is disabled, the address pointer does not automatically increment after each byte is clocked during a serial transfer. This feature is useful when it is desired to continuously poll (read) or modify (write) a register.

The Open-Drain (**ODR**) control bit enables/disables the INT pin for open-drain configuration.

The Interrupt Polarity (**INTPOL**) sets the polarity of the INT pin. This bit is functional only when the ODR bit is cleared, configuring the INT pin as active push-pull.

The Interrupt Clearing Control (**INTCC**) configures how interrupts are cleared. When set (INTCC = 1), the interrupt is cleared when the INTCAP register is read. When cleared (INTCC = 0), the interrupt is cleared when the GPIO register is read.

The interrupt can only be cleared when the interrupt condition is inactive. Refer to **Section 1.7.5 "Clearing Interrupts"** for details.

REGISTER 1-8: **IOCON – I/O EXPANDER CONFIGURATION REGISTER**

R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
BANK	MIRROR	SEQOP	-	-	ODR	INTPOL	INTCC
bit 7							bit 0

| Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 7 **BANK:** Controls how the registers are addressed (see Figure 1-4 and Figure 1-5)

1 = The registers associated with each port are separated into different banks
0 = The registers are in the same bank (addresses are sequential)

bit 6 **MIRROR:** INT pins mirror bit

1 = The INT pins are internally connected in a wired OR configuration
0 = The INT pins are not connected. INTA is associated with Port A and INTB is associated with Port B

bit 5 **SEQOP:** Sequential Operation mode bit.

1 = Sequential operation disabled, address pointer does not increment.
0 = Sequential operation enabled, address pointer increments.

bit 4 **Unimplemented**: Reads as 0

bit 3 **Unimplemented:** Reads as 0

bit 2 **ODR:** Configures the INT pin as an open-drain output.

1 = Open-drain output (overrides the INTPOL bit).
0 = Active driver output (INTPOL bit sets the polarity).

bit 1 **INTPOL:** Sets the polarity of the INT output pin.

1 = Active-high.
0 = Active-low.

bit 0 **INTCC:** Interrupt Clearing Control
1 = Reading INTCAP register clears the interrupt
0 = Reading GPIO register clears the interrupt

1.6.7 PULL-UP RESISTOR CONFIGURATION REGISTER

The GPPU register controls the pull-up resistors for the port pins. If a bit is set the corresponding port pin is internally pulled up with an internal resistor.

REGISTER 1-9: GPPU – GPIO PULL-UP RESISTOR REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 7-0   **PU7:PU0:** Controls the internal pull-up resistors on each pin (when configured as an input or output) <7:0>.
1 = Pull-up enabled.
0 = Pull-up disabled.

FIGURE 1-10:   TYPICAL PERFORMANCE CURVE FOR THE INTERNAL PULL-UP RESISTORS
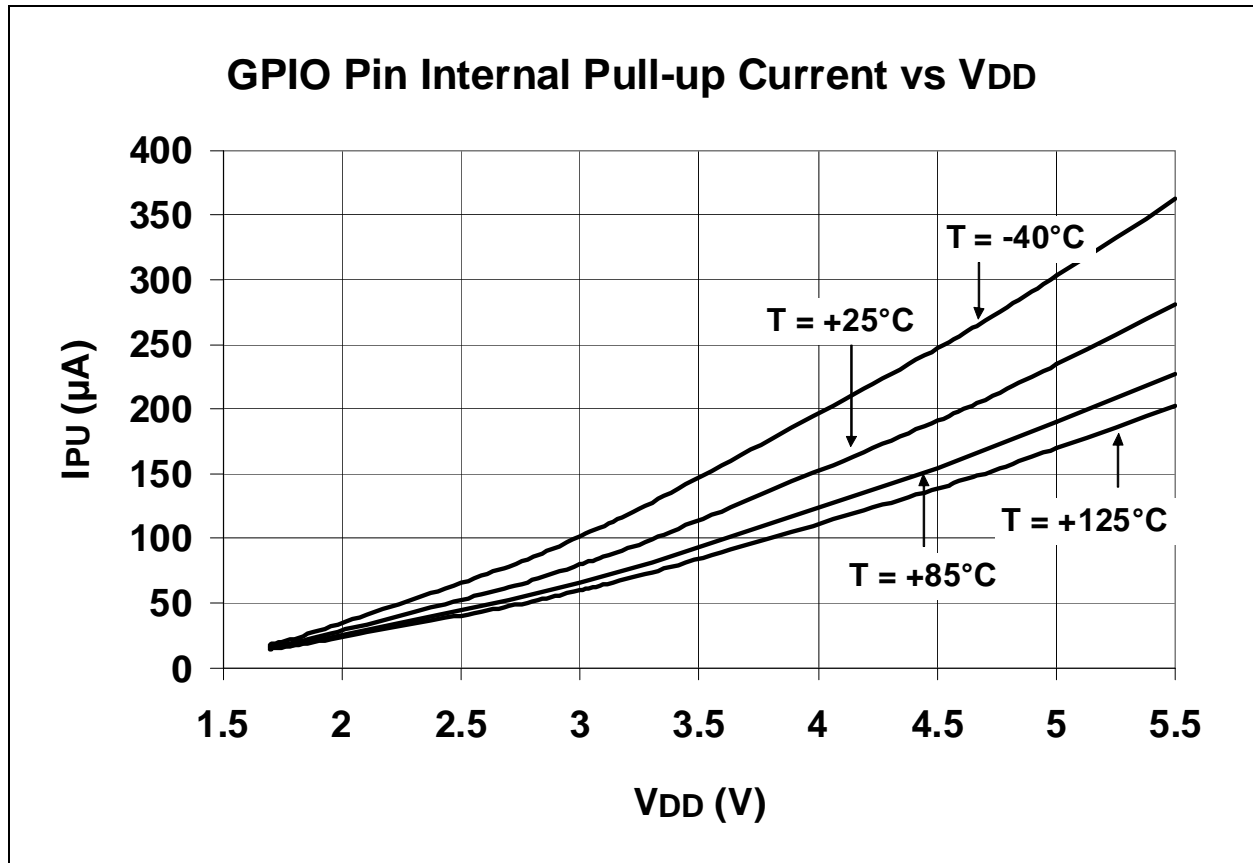
1.6.8 INTERRUPT FLAG REGISTER

The INTF register reflects the interrupt condition on the port pins of any pin that is enabled for interrupts via the GPINTEN register. A 'set' bit indicates that the associated pin caused the interrupt.

This register is 'read only'. Writes to this register will be ignored.

REGISTER 1-10: INTF – INTERRUPT FLAG REGISTER

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 7-0 **INT7:INT0:** Reflects the interrupt condition on the port. Will reflect the change only if interrupts are enabled (GPINTEN) <7:0>.
1 = Pin caused interrupt.
0 = Interrupt not pending.

1.6.9 INTERRUPT CAPTURE REGISTER

The INTCAP register captures the GPIO port value at the time the interrupt occurred. The register is 'read only' and is updated only when an interrupt occurs. The register will remain unchanged until the interrupt is cleared via a read of INTCAP or GPIO.

REGISTER 1-11: INTCAP – INTERRUPT CAPTURED VALUE FOR PORT REGISTER

R-x	R-x	R-x	R-x	R-x	R-x	R-x	R-x
ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **ICP7:ICP0:** Reflects the logic level on the port pins at the time of interrupt due to pin change <7:0>.
1 = Logic-high.
0 = Logic-low.

1.6.10   PORT REGISTER

The GPIO register reflects the value on the port. Reading from this register reads the port. Writing to this register modifies the Output Latch (OLAT) register.

REGISTER 1-12:   GPIO – GENERAL PURPOSE I/O PORT REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0   **GP7:GP0:** Reflects the logic level on the pins <7:0>.
                1 = Logic-high.
                0 = Logic-low.

1.6.11   OUTPUT LATCH REGISTER (OLAT)

The OLAT register provides access to the output latches. A read from this register results in a read of the OLAT and not the port itself. A write to this register modifies the output latches that modifies the pins configured as outputs.

REGISTER 1-13:   OLAT – OUTPUT LATCH REGISTER 0

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 7-0   **OL7:OL0:** Reflects the logic level on the output latch <7:0>.
1 = Logic-high.
0 = Logic-low.

1.7 Interrupt Logic

If enabled, the MCP23X18 activates the INTn interrupt output when one of the port pins changes state or when a pin does not match the pre-configured default. Each pin is individually configurable as follows:

- Enable/disable interrupt via GPINTEN
- Can interrupt on either pin change or change from default as configured in DEFVAL

Both conditions are referred to as Interrupt on Change (IOC).

The Interrupt Control (INT) Module uses the following registers/bits:

- IOCON.MIRROR - controls if the two interrupt pins mirror each other.
- GPINTEN - Interrupt enable register
- INTCON - Controls the source for the IOC
- DEFVAL - Contains the register default for IOC operation

1.7.1 INTA AND INTB

There are two interrupt pins, INTA and INTB. By default, INTA is associated with GPAn pins (Port A) and INTB is associated with GPBn pins (Port B). Each port has an independent signal which is cleared if its associated GPIO or INTCAP register is read.

1.7.1.1 Mirroring the INT pins

Additionally, the INTn pins can be configured to mirror each other so that any interrupt will cause both pins to go active. This is controlled via IOCON.MIRROR.

If IOCON.MIRROR = 0, the internal signals are routed independently to the INTA and INTB pads.

If IOCON.MIRROR = 1, the internal signals are OR'ed together and routed to the INTn pads. In this case, the interrupt will only be cleared if the associated GPIO or INTCAP is read (see Table 1-6).

TABLE 1-6: INTERRUPT OPERATION (IOCON.MIRROR = 1)

Interrupt Condition	Read Port N*	Interrupt Result
GPIOA	Port A	Clear
	Port B	Unchanged
GPIOB	Port A	Unchanged
	Port B	Clear
GPIOA and GPIOB	Port A	Unchanged
	Port B	Unchanged
	Both Port A and Port B	Clear

* Port n = GPIOn or INTCAPn

1.7.2 IOC FROM PIN CHANGE

If enabled, the MCP23X18 will generate an interrupt if a mismatch condition exists between the current port value and the previous port value. Only IOC enabled pins will be compared. See GPINTEN and INTCON registers.

1.7.3 IOC FROM REGISTER DEFAULT

If enabled, the MCP23X18 will generate an interrupt if a mismatch occurs between the DEFVAL register and the port. Only IOC enabled pins will be compared. See GPINTEN, INTCON, and DEFVAL registers.

1.7.4 INTERRUPT OPERATION

The INTn interrupt output can be configured as "active low", "active high", or "open drain" via the IOCON register.

Only those pins that are configured as an input (IODIR register) with interrupt-on-change (IOC) enabled (GPINTEN register) can cause an interrupt. Pins defined as an output have no effect on the interrupt output pin.

Input change activity on a port input pin that is enabled for IOC will generate an internal device interrupt and the device will capture the value of the port and copy it into INTCAP.

The first interrupt event will cause the port contents to be copied into the INTCAP register. Subsequent interrupt conditions on the port will not cause an interrupt to occur as long as the interrupt is not cleared by a read of INTCAP or GPIO.

1.7.5 CLEARING INTERRUPTS

The interrupt will remain active until the INTCAP or GPIO register is read (depending on IOCON.INTCC). Writing to these registers will not affect the interrupt. The interrupt condition will be cleared after the LSb of the data is clocked out during a Read command of GPIO or INTCAP (depending on IOCON.INTCC).

> **Note:** Assuming IOCON.INTCC = 0 (INT cleared on GPIO read): The value in INTCAP can be lost if GPIO is read before INTCAP while another IOC is pending. After reading GPIO, the interrupt will clear and then set due to the pending IOC, causing the INTCAP register to update.

1.7.6 INTERRUPT CONDITIONS

There are two possible configurations to cause interrupts (configured via INTCON):

1. Pins configured for **interrupt-on-pin-change** will cause an interrupt to occur if a pin changes to the opposite state. The default state is reset after an interrupt occurs. For example, an interrupt occurs by an input changing from 1 to 0. The new initial state for the pin is a logic 0.

2. Pins configured for **interrupt-on-change from register value** will cause an interrupt to occur if the corresponding input pin differs from the register bit. The interrupt condition will remain as long as the condition exists, regardless if the INTAP or GPIO is read.

See Figure 1-11 and Figure 1-12 for more information on interrupt operations.

FIGURE 1-11: INTERRUPT-ON-PIN-CHANGE

Port value is captured into INTCAP

Read GPIO or INTCAP

Port value is captured into INTCAP

FIGURE 1-12: INTERRUPT-ON-CHANGE FROM REGISTER DEFAULT

Port value is captured into INTCAP

Read GPIO or INTCAP

(INT clears only if interrupt condition does not exist.)

NOTES:

2.0   ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings [†]

Ambient temperature under bias..-40°C to +125°C

Storage temperature .... -65°C to +150°C

Voltage on V_{DD} with respect to V_{SS} .... -0.3V to +7.0V

Voltage on $\overline{RESET}$ with respect to V_{SS} .... -0.3V to +14V

Voltage on all other pins with respect to V_{SS} (except V_{DD} and GPIOA/B) .... -0.6V to (V_{DD} + 0.6V)

Voltage on GPIO Pins: .... -0.6V to 5.5V

Total power dissipation (Note 1)..700 mW

Maximum current out of V_{SS} pin ....400 mA

Maximum current into V_{DD} pin ....125 mA

Input clamp current, I_{IK} (V_I < 0 or V_I > V_{DD})...±20 mA

Output clamp current, I_{OK} (V_O < 0 or V_O > V_{DD}) ....±20 mA

Maximum output current sunk by any Output pin...25 mA

Maximum output current sunk by any Output pin (V_{DD} = 1.8V) ....10 mA

Maximum output current sourced by any Output pin ....25 mA

Maximum output current sourced by any Output pin (V_{DD} = 1.8V)...10 mA

Note: Power dissipation is calculated as follows:
Pdis = V_{DD} x {I_{DD} - $\sum$ I_{OH}} + $\sum$ {(V_{DD}-V_{OH}) x I_{OH}} + $\sum$(V_{OL} x I_{OL})

[†] **NOTICE:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

2.1   DC CHARACTERISTICS

DC Characteristics		Operating Conditions (unless otherwise indicated): 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C					
Param No.	Characteristic	Sym	Min	Typ[2]	Max	Units	Conditions
D001	Supply Voltage	VDD	1.8	—	5.5	V	
D002	VDD Start Voltage to Ensure Power-on Reset	VPOR	—	VSS	—	V	
D003	VDD Rise Rate to Ensure Power-on Reset	SVDD	0.05	—	—	V/ms	Design guidance only. Not tested.
D004	Supply Current	IDD	—	—	1	mA	SCL/SCK = 1 MHz
D005	Standby (Idle) current	IDDS	—	—	1	µA	−40°C ≤ TA ≤ +85°C
			—	—	6	µA	+85°C ≤ TA ≤ +125°C
	Input Low-Voltage						
D031	$\overline{CS}$, GPIO, SCL/SCK, SDA, SI, $\overline{RESET}$	VIL	VSS	—	0.2 VDD	V	
	Input High-Voltage						
D041	$\overline{CS}$, SCL/SCK, SDA, SI, $\overline{RESET}$	VIH	0.8 VDD	—	VDD	V	
	GPIO	VIH	0.8 VDD	—	5.5	V	
	Input Leakage Current						
D060	I/O port pins	IIL	—	—	±1	µA	VSS ≤ VPIN ≤ VDD,
	Output Leakage Current						
D065	I/O port pins	ILO	—	—	±1	µA	VSS ≤ VPIN ≤ VDD,
D070	GPIO internal pull-up current	IPU	—	220	—	µA	VDD = 5V, GP Pins = VSS Note 1
	Output Low-Voltage						
D080	GPIO	VOL	—	—	0.6	V	IOL = 8.5 mA, VDD = 4.5V (open-drain)
	INT		—	—	0.6	V	IOL = 1.6 mA, VDD = 4.5V
	SO, SDA		—	—	0.6	V	IOL = 3.0 mA, VDD = 1.8V
	SDA		—	—	0.8	V	IOL = 3.0 mA, VDD = 4.5V
	Output High-Voltage						
D090	INT, SO	VOH	VDD – 0.7	—	—	V	IOH = -3.0 mA, VDD = 4.5V
			VDD – 0.7	—	—		IOH = -400 µA, VDD = 1.8V
	Capacitive Loading Specs on Output Pins						
D101	GPIO, SO, INT	CIO	—	—	50	pF	
D102	SDA	CB	—	—	400	pF	

Note 1: This parameter is characterized, not 100% tested.

   2: Data in the Typical ("Typ") column is at 5V, +25°C unless otherwise stated.

2.2   AC CHARACTERISTICS

FIGURE 2-1:   **LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS**

FIGURE 2-2:   **RESET AND DEVICE RESET TIMER TIMING**

TABLE 2-1:   **RESET AND DEVICE RESET TIMER REQUIREMENTS**

AC Characteristics		Standard Operating Conditions (unless otherwise specified) 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C.					
Parameter No.	**Sym**	**Characteristic**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
30	TRSTL	RESET Pulse Width (low)	1	—	—	µs	VDD = 5.0V
32	THLD	Device active after reset high	—	0	—	µs	VDD = 5.0V
31	TPOR	POR at device power up	—	20	—	µs	VDD = 5.0V
34	TIOZ	Output Hi-impedance from RESET Low	—	—	1	µs	

Note 1:   This parameter is characterized, not 100% tested.

   2:   Data in the Typical ("Typ") column is at 5V, +25°C, unless otherwise stated.

TABLE 2-2: GP AND INT PINS

AC Characteristics		Standard Operating Conditions (unless otherwise specified) 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C.					
Parameter No.	Sym	Characteristic	Min	Typ(2)	Max	Units	Conditions
50	t$_{GPOV}$	Serial data to output valid	—	—	500	ns	
51	t$_{INTD}$	Interrupt pin disable time	—	—	600	ns	
52	t$_{GPIV}$	GP input change to register valid	—	450	—	ns	**Note 1**
53	t$_{GPINT}$	IOC event to INT active	—	—	600	ns	
54	t$_{GLITCH}$	Glitch filter on GP pins	—	—	50	ns	**Note 1**

Note 1: This parameter is characterized, not 100% tested.

2: Data in the Typical ("Typ") column is at 5V, 25°C, unless otherwise stated.

FIGURE 2-3: GPIO AND INT TIMING

TABLE 2-3: HARDWARE ADDRESS LATCH TIMING

AC Characteristics	Standard Operating Conditions (unless otherwise specified) 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C.						
Parameter No.	**Sym**	**Characteristic**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
40	t_{ADEN}	Time from VDD stable after POR to ADC enable	—	0	—	µs	Note 1
41	t_{ADDRLAT}	Time from ADC enable to address decode and latch	—	50	—	ns	Note 1
42	t_{ADDIS}	Time from raising edge of serial clock to ADC disable	—	10	—	ns	Note 1

Note 1: This parameter is characterized, not 100% tested.

2: Data in the Typical ("Typ") column is at 5V, +25°C, unless otherwise stated..

FIGURE 2-4: HARDWARE ADDRESS LATCH TIMING
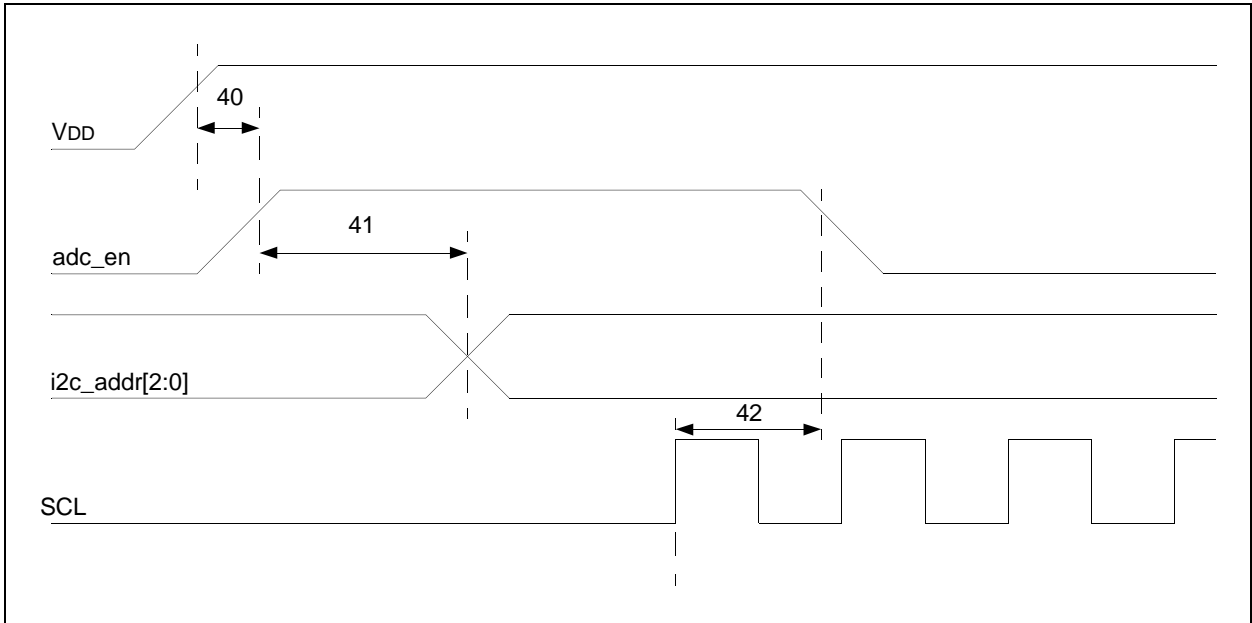
MCP23018/MCP23S18

FIGURE 2-5: I²C BUS START/STOP BITS TIMING

Note 1: Refer to Figure 2-1 for load conditions.

FIGURE 2-6: I²C BUS DATA TIMING

Note 1: Refer to Figure 2-1 for load conditions.

TABLE 2-4: I²C BUS DATA REQUIREMENTS (SLAVE MODE)

I²C™ AC Characteristics		Operating Conditions (unless otherwise indicated): 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C RPU (SCL, SDA) = 1 kΩ, CL (SCL, SDA) = 135 pF.					
Param No.	Characteristic	Sym	Min	Typ	Max	Units	Conditions
100	Clock High Time:	THIGH					
	100 kHz mode		4.0	—	—	µs	1.8V – 5.5V
	400 kHz mode		0.6	—	—	µs	1.8V – 5.5V
	3.4 MHz mode		0.06	—	—	µs	2.7V – 5.5V
101	Clock Low Time:	TLOW					
	100 kHz mode		4.7	—	—	µs	1.8V – 5.5V
	400 kHz mode		1.3	—	—	µs	1.8V – 5.5V
	3.4 MHz mode		0.16	—	—	µs	2.7V – 5.5V
102	SDA and SCL Rise Time:	TR (Note 1)					
	100 kHz mode		—	—	1000	ns	1.8V – 5.5V
	400 kHz mode		20 + 0.1 CB(2)	—	300	ns	1.8V – 5.5V
	3.4 MHz mode		10	—	80	ns	2.7V – 5.5V
103	SDA and SCL Fall Time:	TF (Note 1)					
	100 kHz mode		—	—	300	ns	1.8V – 5.5V
	400 kHz mode		20 + 0.1 CB(2)	—	300	ns	1.8V – 5.5V
	3.4 MHz mode		10	—	80	ns	2.7V – 5.5V
90	START Condition Setup Time:	TSU:STA					
	100 kHz mode		4.7	—	—	µs	1.8V – 5.5V
	400 kHz mode		0.6	—	—	µs	1.8V – 5.5V
	3.4 MHz mode		0.16	—	—	µs	2.7V – 5.5V
91	START Condition Hold Time:	THD:STA					
	100 kHz mode		4.0	—	—	µs	1.8V – 5.5V
	400 kHz mode		0.6	—	—	µs	1.8V – 5.5V
	3.4 MHz mode		0.16	—	—	µs	2.7V – 5.5V
106	Data Input Hold Time:	THD:DAT					
	100 kHz mode		0	—	3.45	µs	1.8V – 5.5V
	400 kHz mode		0	—	0.9	µs	1.8V – 5.5V
	3.4 MHz mode		0	—	0.07	µs	2.7V – 5.5V
107	Data Input Setup Time:	TSU:DAT					
	100 kHz mode		250	—	—	ns	1.8V – 5.5V
	400 kHz mode		100	—	—	ns	1.8V – 5.5V
	3.4 MHz mode		0.01	—	—	µs	2.7V – 5.5V
92	STOP Condition Setup Time:	TSU:STO					
	100 kHz mode		4.0	—	—	µs	1.8V – 5.5V
	400 kHz mode		0.6	—	—	µs	2.7V – 5.5V
	3.4 MHz mode		0.16	—	—	µs	4.5V – 5.5V

Note 1: This parameter is characterized, not 100% tested.

    2: CB is specified from 10 to 400 (pF).

    3: This parameter is not applicable in high-speed mode (3.4 MHz).

TABLE 2-4: I²C BUS DATA REQUIREMENTS (SLAVE MODE) (CONTINUED)

Param No.	Characteristic	Sym	Min	Typ	Max	Units	Conditions
I²C™ AC Characteristics			Operating Conditions (unless otherwise indicated): 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C RPU (SCL, SDA) = 1 kΩ, CL (SCL, SDA) = 135 pF.				
109	Output Valid From Clock:	TAA					
	100 kHz mode		—	—	3.45	µs	1.8V – 5.5V
	400 kHz mode		—	—	0.9	µs	1.8V – 5.5V
	3.4 MHz mode		—	—	0.18	µs	2.7V – 5.5V
110	Bus Free Time:	TBUF (NOTE 3)					
	100 kHz mode		4.7	—	—	µs	1.8V – 5.5V
	400 kHz mode		1.3	—	—	µs	1.8V – 5.5V
	3.4 MHz mode		N/A	—	N/A	µs	2.7V – 5.5V
	Bus Capacitive Loading:	CB (NOTE 2)					
	100 kHz and 400 kHz		—	—	400	pF	**(Note 1)**
	3.4 MHz		—	—	100	pF	**(Note 1)**
	Input Filter Spike Suppression: (SDA and SCL)	TSP					
	100 kHz and 400 kHz		—	—	50	ns	**(Note 1)**
	3.4 MHz		—	—	10	ns	**(Note 1)**

Note 1: This parameter is characterized, not 100% tested.

   2: CB is specified from 10 to 400 (pF).

   3: This parameter is not applicable in high-speed mode (3.4 MHz).

FIGURE 2-7: SPI INPUT TIMING
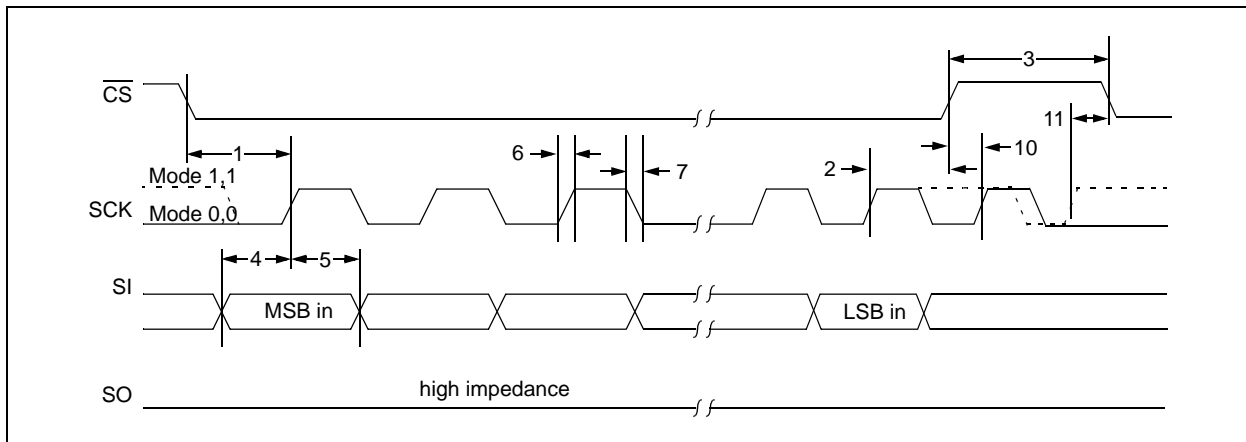
FIGURE 2-8: **SPI OUTPUT TIMING**
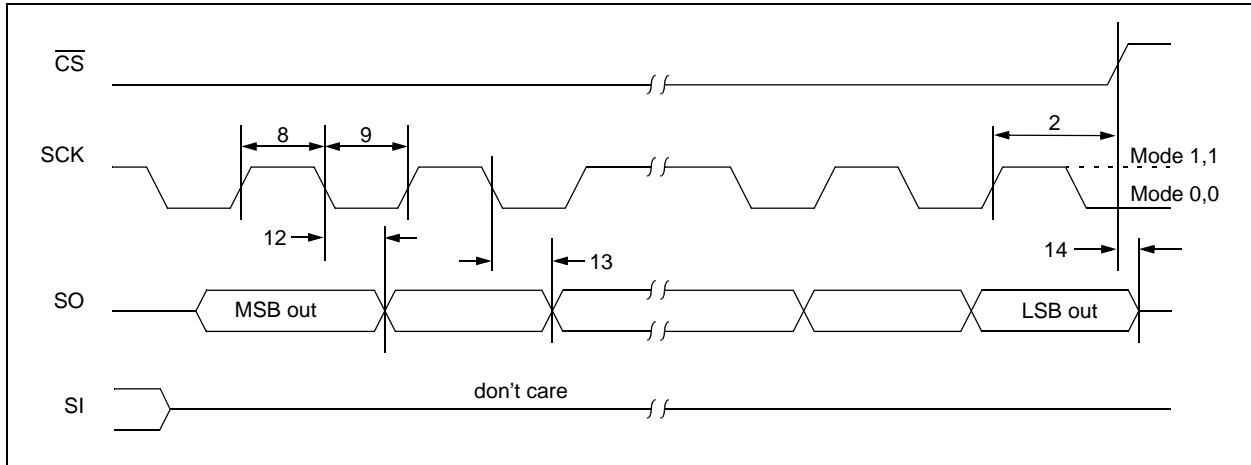
TABLE 2-5: SPI INTERFACE AC CHARACTERISTICS

SPI Interface AC Characteristics		Operating Conditions (unless otherwise indicated): 1.8V ≤ V$_{DD}$ ≤ 5.5V at -40°C ≤ T$_A$ ≤ +125°C.					
Param No.	Characteristic	Sym	Min	Typ	Max	Units	Conditions
	Clock Frequency	F$_{CLK}$	—	—	10	MHz	1.8V – 5.5V
1	$\overline{CS}$ Setup Time	T$_{CSS}$	50	—	—	ns	
2	$\overline{CS}$ Hold Time	T$_{CSH}$	50	—	—	ns	1.8V – 5.5V
3	$\overline{CS}$ Disable Time	T$_{CSD}$	50	—	—	ns	1.8V – 5.5V
4	Data Setup Time	T$_{SU}$	10	—	—	ns	1.8V – 5.5V
5	Data Hold Time	T$_{HD}$	10	—	—	ns	1.8V – 5.5V
6	CLK Rise Time	T$_R$	—	—	2	µs	**Note 1**
7	CLK Fall Time	T$_F$	—	—	2	µs	**Note 1**
8	Clock High Time	T$_{HI}$	45	—	—	ns	1.8V – 5.5V
9	Clock Low Time	T$_{LO}$	45	—	—	ns	1.8V – 5.5V
10	Clock Delay Time	T$_{CLD}$	50	—	—	ns	
11	Clock Enable Time	T$_{CLE}$	50	—	—	ns	
12	Output Valid from Clock Low	T$_V$	—	—	45	ns	1.8V – 5.5V
13	Output Hold Time	T$_{HO}$	0	—	—	ns	
14	Output Disable Time	T$_{DIS}$	—	—	100	ns	

Note 1: This parameter is characterized, not 100% tested.

FIGURE 2-9: TYPICAL PERFORMANCE CURVE FOR SPI TV SPECIFICATION (PARAM #12)

3.0   PACKAGING INFORMATION

3.1   Package Marking Information

24-Lead QFN

```
XXXXX
XXXXXX
XXXXXX
YWWNNN
```

Example

```
23018
E/MJ(e3)
0838
256
```
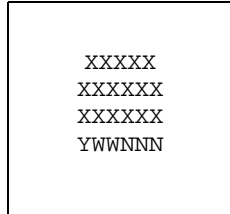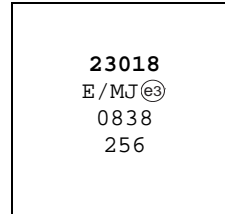
24-Lead SSOP **(MCP23018 only)**

```
XXXXXXXXXXX
XXXXXXXXXXX
    YYWWNNN
```

Example:

```
MCP23018
E/SS(e3)
   0838256
```
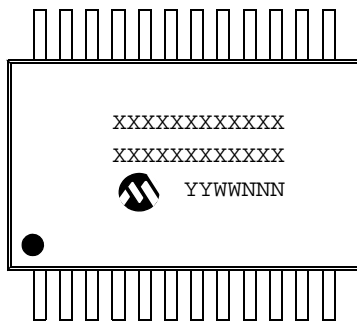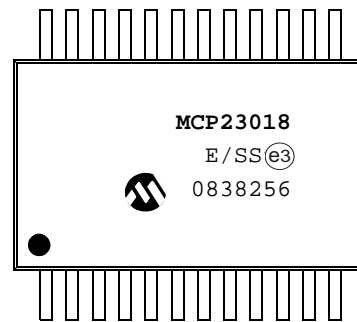
Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
Note:		In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

Package Marking Information (Continued)

28-Lead SPDIP (300 mil)

```
XXXXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXX
   Ⓜ   YYWWNNN
```

Example:

```
       MCP23018
       E/SP (e3)
    Ⓜ  0838256
```

28-Lead SOIC (300 mil)

```
XXXXXXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXXXX
   Ⓜ   YYWWNNN
```

Example:

```
     MCP23018
     E/SO (e3)
      YYWW
   Ⓜ  NNN
```
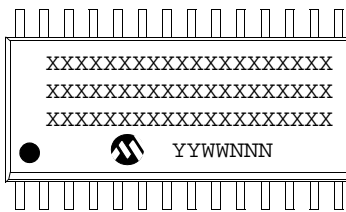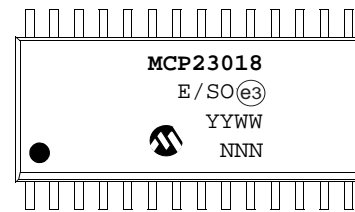
24-Lead Plastic Quad Flat, No Lead Package (MJ) – 4x4x0.9 mm Body [QFN]

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		24	
Pitch	e		0.50 BSC	
Overall Height	A	0.80	0.85	0.90
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		4.00 BSC	
Exposed Pad Width	E2	2.40	2.50	2.60
Overall Length	D		4.00 BSC	
Exposed Pad Length	D2	2.40	2.50	2.60
Contact Width	b	0.20	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

Notes:
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.
    BSC: Basic Dimension. Theoretically exact value shown without tolerances.
    REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-143A

24-Lead Plastic Quad Flat, No Lead Package (MJ) - 4x4 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

SILK SCREEN

RECOMMENDED LAND PATTERN

	Units	MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			2.60
Optional Center Pad Length	T2			2.60
Contact Pad Spacing	C1		3.90	
Contact Pad Spacing	C2		3.90	
Contact Pad Width	X1			0.30
Contact Pad Length	Y1			0.85

Notes:
1. Dimensioning and tolerancing per ASME Y14.5M
    BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2143A

24-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		24	
Pitch	e		0.65 BSC	
Overall Height	A	–	–	2.00
Molded Package Thickness	A2	1.65	1.75	1.85
Standoff	A1	0.05	–	–
Overall Width	E	7.40	7.80	8.20
Molded Package Width	E1	5.00	5.30	5.60
Overall Length	D	7.90	8.20	8.50
Foot Length	L	0.55	0.75	0.95
Footprint	L1		1.25 REF	
Lead Thickness	c	0.09	–	0.25
Foot Angle	φ	0°	4°	8°
Lead Width	b	0.22	–	0.38

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
3. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-132B

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

	Units	INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.
    BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

28-Lead Plastic Small Outline (SO) – Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

	Units		MILLIMETERS	
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		1.27 BSC	
Overall Height	A	–	–	2.65
Molded Package Thickness	A2	2.05	–	–
Standoff §	A1	0.10	–	0.30
Overall Width	E		10.30 BSC	
Molded Package Width	E1		7.50 BSC	
Overall Length	D		17.90 BSC	
Chamfer (optional)	h	0.25	–	0.75
Foot Length	L	0.40	–	1.27
Footprint	L1		1.40 REF	
Foot Angle Top	φ	0°	–	8°
Lead Thickness	c	0.18	–	0.33
Lead Width	b	0.31	–	0.51
Mold Draft Angle Top	α	5°	–	15°
Mold Draft Angle Bottom	β	5°	–	15°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-052B

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (September 2008)

- Original Release of this Document.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.   –   X   /XX

Device   **Temperature   Package**
              Range

Device	MCP23018:	16-Bit I/O Expander w/ I^{2}C™ Interface
	MCP23018T:	16-Bit I/O Expander w/ I^{2}C Interface (Tape and Reel)
	MCP23S18:	16-Bit I/O Expander w/ SPI Interface
	MCP23S18T:	16-Bit I/O Expander w/ SPI Interface (Tape and Reel)

| Temperature Range | E | = -40°C to +125°C (Extended) * |

Package	MJ	= Plastic Quad Flat, No Lead Package (4x4x0.9 mm Body), 24-Lead
	SP	= Skinny Plastic DIP (300 mil Body), 28-Lead
	SO	= Plastic SOIC (300 mil Body), 28-Lead
	SS	= SSOP, (209 mil Body, 5.30 mm), 24-Lead

Examples:

a) MCP23018-E/SP: Extended Temp., 28LD SPDIP package.

b) MCP23018-E/SO: Extended Temp., 28LD SOIC package.

c) MCP23018T-E/SO: Tape and Reel, Extended Temp., 28LD SOIC package.

d) MCP23018-E/SS: Extended Temp., 24LD SSOP package.

e) MCP23018T-E/SS: Tape and Reel, Extended Temp., 24LD SSOP package.

f) MCP23018-E/MJ: Extended Temp., 24LD QFN package.

a) MCP23S18-E/SP: Extended Temp., 28LD SPDIP package.

b) MCP23S18-E/SO: Extended Temp., 28LD SOIC package.

c) MCP23S18T-E/SO: Tape and Reel, Extended Temp., 28LD SOIC package.

d) MCP23S18T-E/MJ: Tape and Reel, Extended Temp., 24LD QFN package.

NOTES:

Note the following details of the code protection feature on Microchip devices:

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- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.

- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.

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- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

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